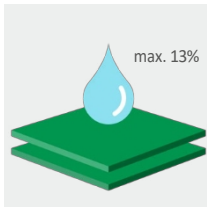


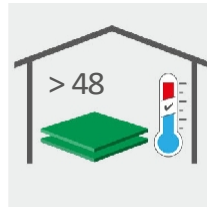
Important information on laying esb & chipboard

Installation boards for use in floors and walls, non-load-bearing or load-bearing in accordance with DIN EN 312:2010

Transport and storage

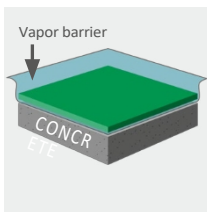


The moisture content of the boards is approx. 9% ex works. During transport and storage, the wood moisture content must not exceed 13%. Ensure that the boards are stored **flat** and **horizontal** on a dry surface.

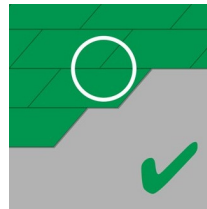


Before installation, the panels must **be stored in the installation room for several days** to allow them to acclimatize. Installation should be carried out under **normal climatic conditions**, i.e. not in overheated, unventilated, cold, or damp rooms.

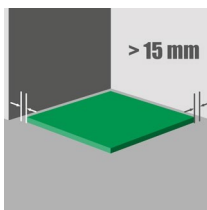
Installation instructions



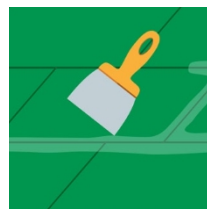
When laying on **ceilings and walls**, check that a **vapor barrier** suitable for the property is used to protect against moisture and install it if necessary.



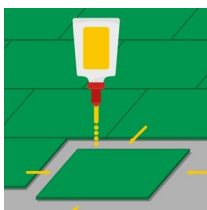
As a general rule, the tiles should be **laid in a pattern**; **cross joints** must **not** occur.



A **border clearance** of 2-3 mm per meter of length and width of the area to be laid must be maintained, **with a minimum of 15 mm**.



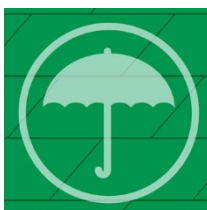
Sand the tile joints flush, fill any joints and sand again.



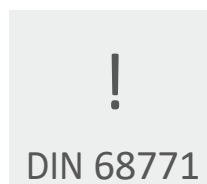
Carefully spread the adhesive **around the boards**, applying it to both sides of the tongue if possible.



Once laid, the panels should be **covered** immediately with the intended covering or **with a PE film** to prevent moisture and damage.



The panels must be **protected from moisture** during use, e.g. from cleaning water or condensation.



DIN 68771 "Wood chipboard subfloors" must be **observed**. Obvious or recognizable technical/quality defects must be reported to your contractual partner immediately after they become known. Complaints after processing/assembly cannot be accepted.